

Application No.: 09/586,525

Docket No.: JCLA5827-R2

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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JAN 26 2004

In re application of :  
Application No. : 09/586,525  
Filed : June 2, 2000  
For : SUBSTRATE STRUCTURE OF FLIP CHIP PACKAGE  
Applicant : Ying-Chou Tsai  
Examiner : Nadav, Ori  
Art Unit : 2811

OFFICIAL

No fee is believed to be due. However, the Commissioner is authorized to charge any fees required in connection with the filing of this paper to account No. 50-0710 (Order No. JCLA5872-R2).

**RESPONSE TO OFFICE COMMUNICAION**

**AMENDMENT AND RESPONSE TO OFFICE ACTION**

**MAIL STOP Non-Fee Amendment**

Commissioner for Patents  
P. O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Office communication dated January 15, 2004, Applicants re-submit the amendment and response with corrected claims. No new matter has been added.

In response to the Office Action dated May 6, 2003, please enter the following amendments and consider the following remarks.